



Application Note

Using the AG40x-xx with a +5 V supply

Because of the small resistance value required to drop the voltage from a +5 V supply to the nominal device voltage for the WJ AG40x-xx gain blocks, the passive biasing configuration shown in the datasheet is not recommended. An active-bias current mirror would be more suitable for operating the AG40x-xx device if only a +5 supply is available. The active-biased circuit maintains a constant current into the collector (output) of the HBT amplifier by continually adjusting the base voltage (input). This configuration allows the user not to use a dropping resistor for the application of the device. HBT devices also generally source varying collector currents over temperature; the constant-current active-bias circuit limits this current variation and allows for temperature compensation due to the varying effects of the V_{be} junction in the biasing transistors.

The active-bias circuit, shown in Figure 1, uses dual PNP transistors to provide a constant current into gain block. The gain block should be connected with the biasing circuit without the use of the dropping resistor. This recommended active-bias constant-current circuit adds 7 components to the parts count for implementation, but should cost only an extra USD\$0.123 to realize (\$0.10 for U1, \$0.0029 for R1, R2, R3, R4, R5, and \$0.0085 for C1).

Temperature compensation is achieved by tracking the voltage variation with the temperature of the emitter-to-base junction of the two PNP transistors. As a 1st order approximation, this is achieved by using matched transistors with approximately the same I_{be} current. Thus the transistor emitter voltage adjusts the amplifier base voltage so that the device draws a constant current, regardless of the temperature. A Rohm dual transistor - UMT1N - is recommended for cost, minimal board space requirements, and to minimize the variation between the two transistors. Minimizing the variability between the base-to-emitter junctions allow more accuracy in setting the current draw.

The value for the resistor components can be determined with KVL circuit theory. R3 is can be determined by:

$$V_3 = R3 * I_1 \quad (1)$$

$$V_{device} = V_{be2} + V_3 = V_{be2} + R3 * I_1 \quad (2)$$

$$R3 = \frac{(V_{device} - V_{be2})}{I_1} \quad (3)$$

Using another equation derived from KVL (equation 4) allows for the derivation of R1 using (3):

$$I_1 = \frac{V_{cc} - V_{be1}}{R1 + R3} \quad (4)$$

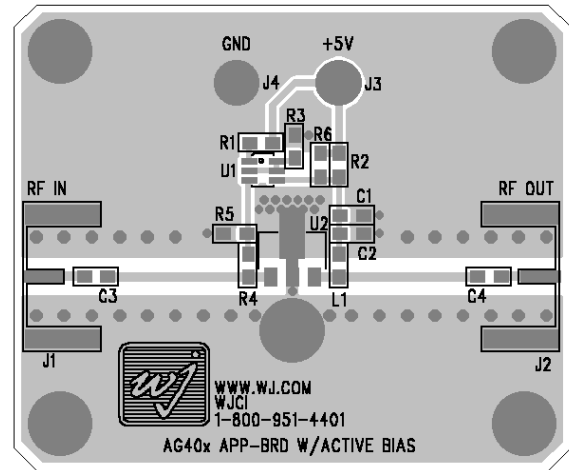
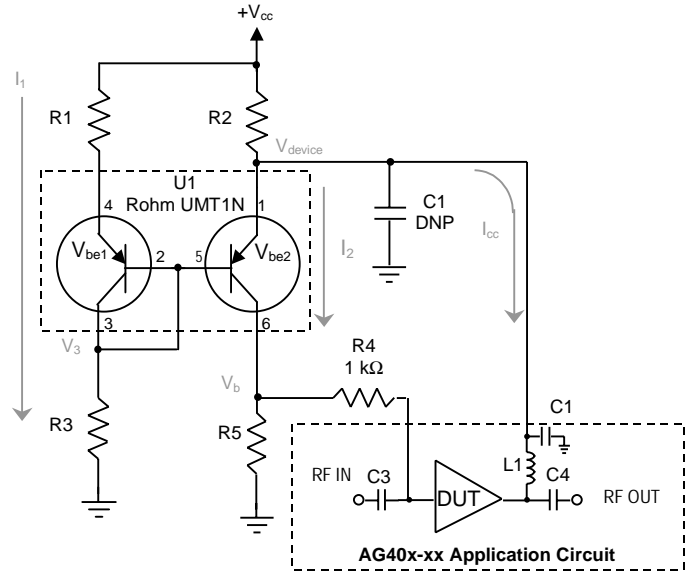
$$R1 = \frac{(V_{cc} - V_{device} + V_{be2} - V_{be1})}{I_1} \quad (5)$$

R2 and R5 can be determined with KVL theory. It is assumed that the no gate current passes through the DUT in forming (7). R4 is used as a high impedance choke to minimize any RF energy entering the biasing circuit from the amplifier input. The value for R4 can be arbitrarily set to be 1 kΩ.

$$R2 = \frac{V_{cc} - V_{device}}{I_{cc} + I_2} \quad (6)$$

$$R5 = \frac{V_b}{I_2} \quad (7)$$

To provide the minimal amount of current variation over temperature, the emitter-to-base junctions of the two transistors should be as closely matched to each other as possible. This can be accomplished by setting the current passing through them I_1 and I_2 to be equal. Thus, V_{be1} and V_{be2} are assumed to be equal. Equations (3), (5), (6), and (7) can be simplified with these assumptions and also setting I_1 and I_2 to be 4 mA. In addition, I_{cc} is assumed to be much larger than I_2 to further simplify the equations.



$$R1 = 250 * (V_{cc} - V_{device}) \quad (8)$$

$$R2 = (V_{cc} - V_{device}) / I_{cc} \quad (9)$$

$$R3 = 250 * V_{device} - V_{be} \quad (10)$$

$$R5 = 250 * V_b \quad (11)$$

Using these equations and assuming the V_{be} to be 0.7 V, the following values are recommended for the WJ AG40x-xx devices. The actual calculated values were rounded to realizable standard sizes. A base voltage V_b of +2 V is assumed to set the collector current for device.

Parameter	AG40x-xx
Supply Voltage: Vcc	+5 V
Vdevice	+4.90 V
Ids	60 mA
R1	22.1 Ω
R2	1.7 Ω
R3	1 kΩ
R4	1 kΩ
R5	500 Ω

The accuracy of I_{cc} is determined directly by the precision of the R2 value. Therefore, a high precision R2 component is recommended. All other resistors can be chosen to be a standard 0603 package size for standard 5% precision tolerance.